

(Discard this page in a sole inventor application)

1	Typewritten Full Name of Joint Inventor	<u>200 Yuji</u>	<u>KASAI</u>
		Given Name	Middle Initial Family Name
2	Inventor's Signature	<u>Yuji Kasai</u>	
3	Date of Signature	<u>February 14, 2005</u>	
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		City	State or Province Country
	Citizenship	<u>Japanese</u>	
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	(Insert complete mailing address, including country)	<u>and Technology, Tsukuba Central 2, 1-1, Umezono 1-Chome,</u>	
		<u>Tsukuba-shi, Ibaraki 305-8568, Japan</u>	
1	Typewritten Full Name of Joint Inventor	<u>300 Tetsuya</u>	<u>HIGUCHI</u>
		Given Name	Middle Initial Family Name
2	Inventor's Signature	<u>Tetsuya Higuchi</u>	
3	Date of Signature	<u>February 14 th, 2005</u>	
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	(Insert complete mailing address, including country)		

Note to Inventor: Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

This form may be executed only when attached to the first page of the Declaration and Power of Attorney of the application to which it pertains.

BEST AVAILABLE COPY

DECLARATION AND POWER OF ATTORNEY
UNDER 35 USC §371(c)(4) FOR

PCT APPLICATION FOR UNITED STATES PATENT

As a below named inventor, I hereby declare that:
 my residence, post office address and citizenship are as stated below under my name;

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought, namely the invention entitled:

DIGITAL CIRCUIT HAVING DELAY CIRCUIT FOR ADJUSTMENT OF CLOCK SIGNAL TIMING

described and claimed in international application number PCT/JP03/08648
 filed July 8, 2003

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56. Under Title 35, U.S. Code §119, the priority benefits of the following foreign application(s) filed within one year prior to my international application are hereby claimed:

Japanese Patent Application No. 2002-200,467 filed July 9, 2002

The following application(s) for patent or inventor's certificate on this invention were filed in countries foreign to the United States of America either (a) more than one year prior to my international application, or (b) before the filing date of the above-named foreign priority application(s):

I hereby appoint the following as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent Office:

James A. Oliff, Reg. No. 27,075; William P. Berridge, Reg. No. 30,024;
 Kirk M. Hudson, Reg. No. 27,562; Thomas J. Pardini, Reg. No. 30,411; and
 Edward P. Walker, Reg. No. 31,450.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO OLIFF & BERRIDGE, P.O. BOX 19928, ALEXANDRIA, VIRGINIA 22320, TELEPHONE (703) 836-6400.

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1 Typewritten Full Name of Sole or First Inventor Eiichi TAKAHASHI
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 2 Inventor's Signature Eiichi Takahashi
 3 Date of Signature February 14, 2005
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IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE ☐

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